

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	MMS/15/9309	
1.3 Title of PCI	HAA SEALING TYPE TAPE for M95640 Thin, M24C64 Thin and M24C16 Ultra-Thin-WLCSP	
1.4 Product Category	M24C16-DFCU6TP/K M95640-DFCT6TP/K M24C64-DFCT6TP/K	
1.5 Issue date	2015-06-29	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Benoit RODRIGUES
2.1.2 Marketing Manager	Hubert LEDUC
2.1.3 Quality Manager	Rita PAVANO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, ...	STATSChipPAC (Singapore)

4. Description of change

	Old	New
4.1 Description	Cover Tape: Pressure Sensitive Cover Tape 2668 (PSA)	Cover Tape: Heat Activated Cover Tape 2671A (HAA)
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	- Form: HAA sealing type (packing material)	

5. Reason / motivation for change

5.1 Motivation	The change to HAA sealing type tape will make easier the unreeling operation at customer site.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	N/A
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7. Timing / schedule

7.1 Date of qualification results	2015-06-26
7.2 Intended start of delivery	2015-07-03
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)
9309PpPrdtLst.pdf PCI HAA for M24C64 M24C16 M95640 WLCSP.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	M24C16-DFCU6TP/K	
	M95640-DFCT6TP/K	

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